



Quality/Purity of copper used in Jantzen Audio inductors:

All Jantzen Audio inductors, both wire and foil based are made with copper that is in accordance with ETP (Electrolytic-Tough-Pitch) C11000 and an IACS certification of a minimum of 100% conductivity.

C11000 copper has a guaranteed purity of 99.9% or higher. The copper purity will often be higher, but 99.9% is the margin which our suppliers of copper wire and copper foil will guarantee as a minimum.

The oxygen content of ETP C11000 certified copper is between 0.02 and 0.04%.

Copper types and copper purity used for audio grade inductors in general:

Oxygen free copper C10100 OFE is 99.99% pure copper wire or foil and is mainly used for appliance areas where it is important that the copper does not contain any Silver (Ag) or other foreign elements.

This can be i.e. cryogenics, aerospace or other industries where the purity and oxygen level of the copper used needs to be 99.99% pure and virtually free of oxygen.

For audio appliance using Oxygen free copper C10100 OFE copper has no advantages, as there is no possible way for the human ear to hear any difference in performance between inductors made from C10100 OFE copper or ETP (Electrolytic-Tough-Pitch) C11000 copper.

Using Oxygen free copper C10100 OFE is 99.99% in audio inductors would make them unnecessarily expensive and to our best knowledge no-one in the audio industry can claim, nor prove that they use this grade of copper with certificates or independent lab tests.

As a rule of thumb, any inductors using Oxygen free copper should be 3 to 4 times more expensive than the average market price for inductors using ETP C11000 certified copper (99.9%).



Inductors versus capacitors:

For capacitors, pure silver or Oxygen free copper C10100 OFE is often used for the lead-wires, because capacitors in their nature are more revealing when it comes to audio appliance.

Inductors play an equally important role in crossovers, but in a different way.

Inductors do not have the ability to "color" or "change" the sound profile in the same direct way that changing/upgrading capacitors does.

The role of inductors have more to do with performance in areas like increased power handling and adding dynamic headroom by choosing the right type of inductor.

As long as the inductor is well made from high quality copper the signal pathing will be as it should be.

What does it take to make a good audio grade inductor?

The most important factor for a good quality audio grade inductor is that the copper used is of a certified good quality, like the ETP (Electrolytic-Tough-Pitch) C11000 copper we use at Jantzen Audio any copper grade above this grade has no technical advantages or performance enhancing qualities for audio appliance. Using a higher grade would make inductors more expensive than necessary.

Furthermore the winding integrity has to be impeccable and also the overall quality of the inductor is of course a factor.

At Jantzen Audio we wind our induction coils (wire and foil) on semi-automatic machines and we use the "baked wire" technology to make wire based coils with no need for plastic bobbins.

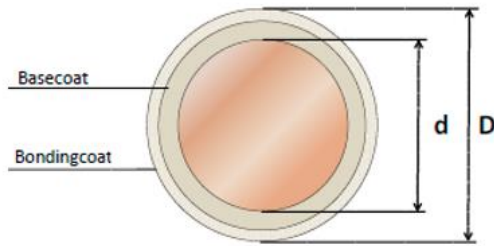
For foil type inductors we have built our own special semi-automatic machines that allow for tight windings and full control of layering and insulation.

This means we can offer these very low tolerances:

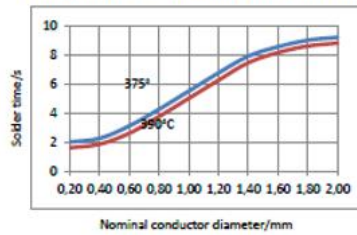
- **Air Core, Iron Core & Litz Wire inductors:** +/- 3% (inductance) & +/- 5% (RDC)
- **C-Coil inductors:** +/- 5% (inductance) & +/- 10% (RDC)
- **Wax Coil & Cross Coil inductors:** +/- 2% (inductance) & +/- 5% (RDC)



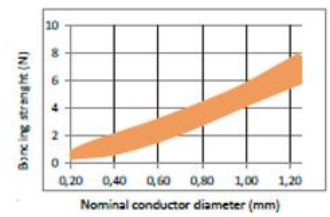
Copper wire (supplier information)



Approximate solder time, independent of grade



Bonding strenght



D - d = Increase

(Increase of bondingcoat may be lower than stipulated by IEC, but total increase (D-d) and bonding strenght within specified values guaranteed)

| Main characteristics | Test method | Property values | Test values for a 180 sample (1,00 mm, Gr1) |
|-------------------------------|-------------------------------|-----------------------------|---|
| Thermal properties: | | | |
| Heat shock | IEC 60851 - 6.3 | ≥ 200°C | ≥ 200°C |
| Cut-through | IEC 60851- 6.4 | ≥ 230°C | ≥ 240°C |
| Temperature index | IEC 60172 | ≥ 180°C1) | ≥ 180°C *1) |
| Electrical properties: | | | |
| Conductor resistance | IEC 60851 - 5.3 | 0,01724 Ωmm ² /m | 0,01724 Ωmm ² /m |
| Conductivity | 1/R | > 58 m/(Ωmm ²) | > 58 m/(Ωmm ²) |
| Breakdown voltage | IEC 60851 - 5.4 | IEC 60317-0-12) | 7,8 kV |
| Mechanical properties: | | | |
| Elongation | IEC 60851-3.3 | IEC 60317-0-1 *2) | 40% |
| Springiness | Springiness *3) | IEC 60317-0-12) | 41° |
| | IEC 60851-3.4 | | |
| | Springback *4) | ≤ 5° | - |
| Flexibility | IEC 60851-3.5 - Mandrel wind. | 1 x Ø | 1 x Ø |
| Adherence | Jerktest *5) | No loss of adhesion | OK |
| | IEC 60851-3.5 Peeltest *6) | min. 110 *7) | - |
| Bonding: | IEC 60851-3.7 | IEC 60317-35.18 | 6,0 N at 190°C |

1. According to supplier certificate
2. Values depend on dimension
3. Up to an including 1,60 mm
4. Over 1,60 mm
5. Up to and including 1,00 mm
6. Over 1,00 mm
7. Revolutions x nominal dimension

Values above are for information only.
All values noted are typical and can vary between lots and dimensions.



Copper wire (supplier information)

Properties:

- Class 180, grade 1B and 2B
- Directly solderable
- Short time solder
- Can be bonded at 180°C - 200°C
- Excellent resistance to mechanical stress

Specifications:

- C11000 - IEC 60317-35 – 100% IACS

Class 180:

- Temperate index ≥ 180 °C
- Heat shock ≥ 200 °C

Conductor material:

- EN 1977 - ETP1 CW003A
- EN 1977 - ETP CW004A
- ASTM B49 - ETP C11000/C11040

Insulation:

- Basecoat: Polyurethane
- Bondingcoat: Modified aliphatic polyamide

Dimension range:

- 180 – Gr. 1B = $0,200 \leq \varnothing \leq 2,000$ mm
- 180 – Gr. 2B = $0,200 \leq \varnothing \leq 2,000$ mm



Copper foil (supplier information)


Certificate of products

R-8-017A

| | | | | | | | | | |
|------------------------|-----------------------|---------|-------------------------------|--------|--------|---------|--------|--------|---------------------------------|
| Customer No. | | YMA0017 | | | | | | | |
| Raw material | | TU1 | | Sizes | | 0.18*47 | | | |
| Test items | | | STD | Value | | | | Result | Testing tool |
| | | | | 1 | 2 | 3 | 4 | | |
| Sizes | Width (D: mm) | | 47 ⁺⁶ ₄ | 47.06 | 47.08 | 47.10 | 47.06 | OK | Vernier Caliper |
| | Thickness (H: mm) | | 0.18 ± 0.01 | 0.183 | 0.185 | 0.186 | 0.189 | OK | micrometer |
| chemical component (%) | Element | Cu | Fe | Zn | Sn | Bi | Ni | / | FAAS |
| | STD | ≥99.97 | ≤0.004 | ≤0.003 | ≤0.002 | ≤0.001 | ≤0.002 | | |
| | Results | Rest | 0.0020 | 0.0015 | 0 | 0.00020 | 0.0011 | OK | |
| RoHS (%) | Element | Cd | Pb | Hg | CR(VI) | / | | | x-ray fluorescence spectrometer |
| | STD | ≤0.0005 | ≤0.01 | ≤0.05 | ≤0.01 | | | | |
| | Results | ND | ND | ND | ND | OK | | | |
| Surface | Smooth, flawless | | | | | | OK | | |
| Notes: | ND means No, or ≤2PPm | | | | | | | | |
| Result: | OK | | | | | | | | |
| | | | | | | | | | |



Independent lab test

| | | |
|---|--|------------|
|  | INSTITUTE OF NON-FERROUS METALS ANALYTICAL CHEMISTRY DEPARTMENT | |
| | <i>44-100 Gliwice, Sowińskiego 5, tel. 32 2 380 278, fax 32 2 316 933</i> <i>e-mail: ewasz@imn.gliwice.pl</i> | |
| REPORT OF TESTING No: 0464/2016 | Date | 2016-07-27 |
| | Page | 1/1 |

1. Customer

Polink Wilkowo sp. z o.o.
 66-200 Świebodzin
 Wilkowo 62

2. Testing objects, properties

Testing objects : two samples marked as „Cu – foil and Cu – winding wire”
 Kind of tests: semi-quantitative analysis
 Date of receiving the samples for testing : July 2016

3. Testing methods

- X-ray fluorescence method (XRF).

4. Results of tests

| Sample „Cu - foil” | |
|--------------------|------------------|
| Element | Concentration, % |
| Cu | 99,9 |
| Si | 0,04 |
| S | 0,03 |
| Fe | 0,02 |
| Cl | 0,02 |
| Al | 0,01 |

| Sample „Cu – Winding wire” | |
|----------------------------|------------------|
| Element | Concentration, % |
| Cu | 99,8 |
| Si | 0,05 |
| Mn | 0,04 |
| Zn | 0,04 |
| S | 0,03 |
| Al | 0,03 |

.....End of Report.....


 Contractor

Z-ca Kierownika
 Zakładu Chemii Analitycznej

 mgr inż. Andrzej Hrynyszyn
 Chief of Department

- Results presented in the report concern only the objects mentioned in the report.
- Written complaint could be turn up to 30 days from the date of receiving the report.
- After testing, the test object shall be deposited in the archives, where it is stored for a period of two months. Report could be duplicated only entirely. Permission of Institute of Non-Ferrous Metals is necessary for each duplication.



Important notes regarding the independent lab test

- Polink Wilkowo Sp.z.o.o. is the name of our production company / factory in Poland.
- The test was done by an independent government funded institute for non-ferrous metals (chemical analysis department)
- The X-Ray fluorescence method (XRF) can only show 1 digit for purity measurements. Different contaminants found are shown in percentages on their own, then deducted from 100% pureness factor.
- The test has a tolerance of three hundreds in precision (+/- 0.03%)
- When comparing the purity measurement of a lab test with the purity statement issued by suppliers, one must take into account that the purity measurements done by copper suppliers are based on measuring the first processing of copper mass/rods and not further processed copper products like winding wire or foil.
- Once the raw copper mass has been processed, outside contaminants like Sulphur (S), other airborne impurities and impurities originating from the processing process are inevitable and will lower the purity slightly compared to the raw unprocessed copper.
- The independent lab test shows that the processed copper we use have the following purity (factored in with a +/- 0.03% margin as shown below):

Copper foil: 99.85% to 99.91% purity

Copper wire: 99.78% to 99.84% purity